PCN	l Number:	2016080400	1			PCN Da	ite:	8/5/2016	
Title	e: Datasheet for	DAC5675A						. ,	
	tomer Contact:	PCN Manager		De	ept: Quality Services				
Cha	nge Type:							-	
	Assembly Site			Design		Wafer	Bum	p Site	
Ħ	Assembly Process		_	Data Sheet	$\overline{\Box}$			p Material	
Assembly Materials		S	F	Part number change		Wafer	Wafer Bump Process		
	Mechanical Specification		_	est Site		Wafer	Fab S	Site	
Packing/Shipping/Labeling		Labeling	T	est Process		Wafer	Fab I	Materials	
					Wafer	Fab I	Process		
		I	Not	ification Details					
Des	cription of Chang	e:							
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.									
		, ,							
4	TEXAS INSTRUMENTS			004022	4D N	IOVEMBED 20	OA DEVI	DAC5675A	
_					4D - N	OVEMBER 20	JU4-REVI	SED JULY 2016	
Cha	anges from Revision C (I	March 2005) to Rev	/isior	ı D				Page	
<ul> <li>Added ESD Ratings, Recommended Operating Conditions, Thermal Information, Detailed Description section, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, Mechanical, Packaging, and Orderable Information section</li></ul>									
Changed AV <sub>DD</sub> to DV <sub>DD</sub> From: -3.6 to +3.6 To: -0.7 to +0.7 in the Absolute Maximum Ratings									
De	datasheet number vice Family C5675A	will be changi		Change From: SBAS334C				ge To:	
DA	C3673A			3DA3334C			SDAS	3334D	
http	://www.ti.com/prod			latasheet links provided.					
	son for Change:								
To n	nore accurately refl	ect device cha	ract	teristics.					
Anti	icipated impact o	n Fit, Form, I	Fun	ction, Quality or Reliab	oilit	y (posi	tive	negative):	
	anticipated impact. ne actual device.	This is a speci	fica	tion change announceme	nt d	only. The	ere ar	e no changes	
Changes to product identification resulting from this PCN:									
Non	-			•					
Pro	duct Affected:								
DA	C5675AIPHP	DAC5675AIP	HPC	G4 DAC5675AIPHPR	₹				
	-	· · · · · · · · · · · · · · · · · · ·							

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
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